

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KOICHI SAKAGUCHI	10/31/2016
KATSUHITO SATO	10/31/2016
<b>RECEIVING PARTY DATA</b>	
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<b>Internal Address:</b>	NAKAMURA-KU,
<b>City:</b>	NAGOYA-SHI, AICHI
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	450-6424
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29583632
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<b>NAME OF SUBMITTER:</b>	JEREMY M. JAY
<b>SIGNATURE:</b>	/Jeremy M. Jay/
<b>DATE SIGNED:</b>	11/14/2016
<b>Total Attachments: 1</b>	
source=726723 Assignment#page1.tif	

# ASSIGNMENT

Whereas, I/we,

NameAddress1) **Koichi SAKAGUCHI**c/o Sintokogio, Ltd., Toyokawa-Seisakusho,  
1, Honohara 3-chome,  
Toyokawa-shi, Aichi 442-8505 Japan2) **Katsuhito SATO**c/o Sintokogio, Ltd., Toyokawa-Seisakusho,  
1, Honohara 3-chome,  
Toyokawa-shi, Aichi 442-8505 Japan

hereinafter called assignor(s), have invented certain improvements in  
**Flask-less Molding Machine**

and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below:

filed on November 08, 2016, Serial No. 29/583,632; and

Whereas

SINTOKOGIO, LTD.

28-12, Meieki 3-chome, Nakamura-ku,  
Nagoya-shi, Aichi 450-6424 Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

INVENTORSDATE SIGNED

1) :

Koichi SakaguchiOctober 31, 2016

Name :

Koichi SAKAGUCHI

2) :

Katsuhito SatoOctober 31, 2016

Name :

Katsuhito SATO